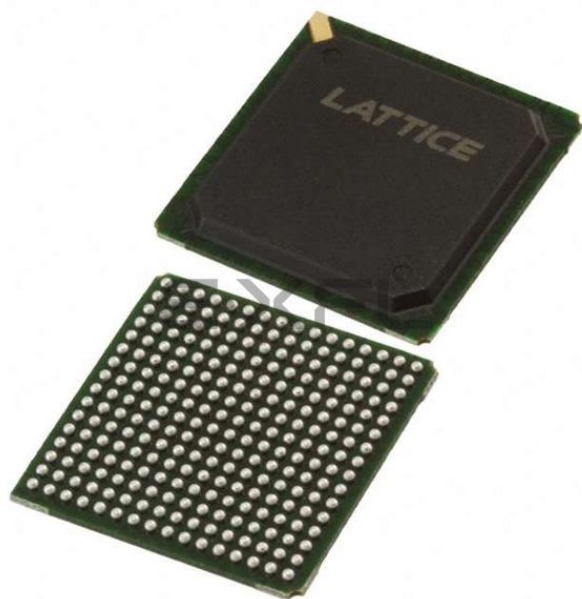




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Understanding [Embedded - FPGAs \(Field Programmable Gate Array\)](#)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

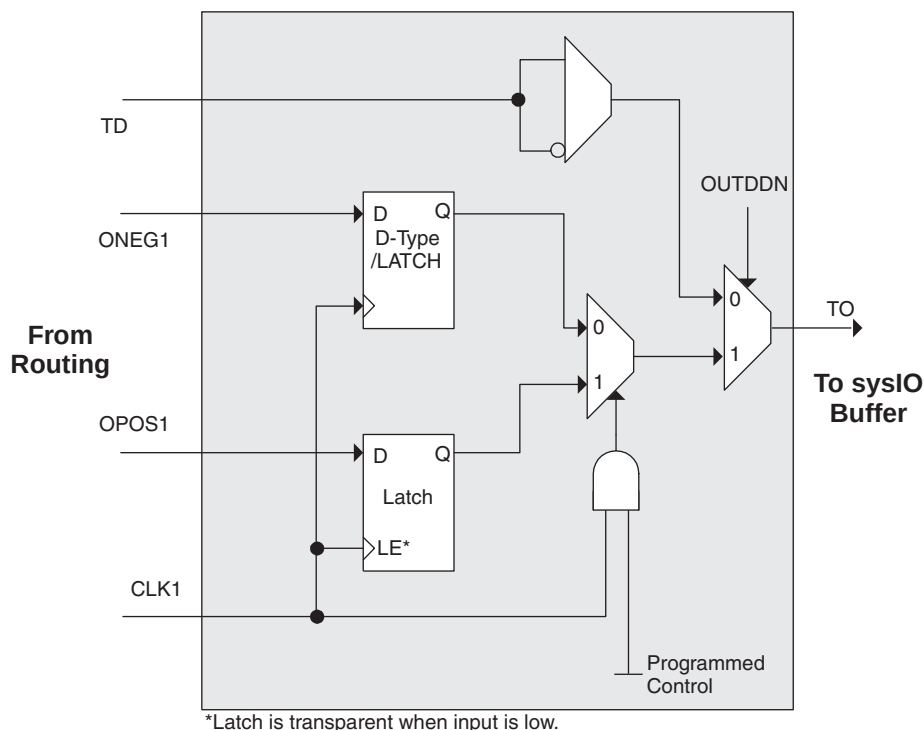
Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details

Product Status	Obsolete
Number of LABs/CLBs	-
Number of Logic Elements/Cells	15400
Total RAM Bits	358400
Number of I/O	195
Number of Gates	-
Voltage - Supply	1.14V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	-40°C ~ 100°C (TJ)
Package / Case	256-BGA
Supplier Device Package	256-FPBGA (17x17)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfec15e-4fn256i

Figure 2-31. Tristate Register Block



Control Logic Block

The control logic block allows the selection and modification of control signals for use in the PIO block. A clock is selected from one of the clock signals provided from the general purpose routing and a DQS signal provided from the programmable DQS pin. The clock can optionally be inverted.

The clock enable and local reset signals are selected from the routing and optionally inverted. The global tristate signal is passed through this block.

DDR Memory Support

Implementing high performance DDR memory interfaces requires dedicated DDR register structures in the input (for read operations) and in the output (for write operations). As indicated in the PIO Logic section, the LatticeEC devices provide this capability. In addition to these registers, the LatticeEC devices contain two elements to simplify the design of input structures for read operations: the DQS delay block and polarity control logic.

DLL Calibrated DQS Delay Block

Source Synchronous interfaces generally require the input clock to be adjusted in order to correctly capture data at the input register. For most interfaces a PLL is used for this adjustment. However in DDR memories the clock (referred to as DQS) is not free running so this approach cannot be used. The DQS Delay block provides the required clock alignment for DDR memory interfaces.

The DQS signal (selected PIOs only) feeds from the PAD through a DQS delay element to a dedicated DQS routing resource. The DQS signal also feeds polarity control logic, which controls the polarity of the clock to the sync registers in the input register blocks. Figures 2-32 and 2-33 show how the DQS transition signals are routed to the PIOs.

The temperature, voltage and process variations of the DQS delay block are compensated by a set of calibration (6-bit bus) signals from two DLLs on opposite sides of the device. Each DLL compensates DQS Delays in its half of the device as shown in Figure 2-33. The DLL loop is compensated for temperature, voltage and process variations by the system clock and feedback loop.

Table 2-14. Supported Output Standards

Output Standard	Drive	V _{CCIO} (Nom.)
Single-ended Interfaces		
LVTTTL	4mA, 8mA, 12mA, 16mA, 20mA	3.3
LVC MOS33	4mA, 8mA, 12mA 16mA, 20mA	3.3
LVC MOS25	4mA, 8mA, 12mA, 16mA, 20mA	2.5
LVC MOS18	4mA, 8mA, 12mA, 16mA	1.8
LVC MOS15	4mA, 8mA	1.5
LVC MOS12	2mA, 6mA	1.2
LVC MOS33, Open Drain	4mA, 8mA, 12mA 16mA, 20mA	—
LVC MOS25, Open Drain	4mA, 8mA, 12mA 16mA, 20mA	—
LVC MOS18, Open Drain	4mA, 8mA, 12mA 16mA	—
LVC MOS15, Open Drain	4mA, 8mA	—
LVC MOS12, Open Drain	2mA, 6mA	—
PCI33	N/A	3.3
HSTL18 Class I, II, III	N/A	1.8
HSTL15 Class I, III	N/A	1.5
SSTL3 Class I, II	N/A	3.3
SSTL2 Class I, II	N/A	2.5
SSTL18 Class I	N/A	1.8
Differential Interfaces		
Differential SSTL3, Class I, II	N/A	3.3
Differential SSTL2, Class I, II	N/A	2.5
Differential SSTL18, Class I	N/A	1.8
Differential HSTL18, Class I, II, III	N/A	1.8
Differential HSTL15, Class I, III	N/A	1.5
LVDS	N/A	2.5
BLVDS ¹	N/A	2.5
LVPECL ¹	N/A	3.3
RSDS ¹	N/A	2.5

1. Emulated with external resistors.

Hot Socketing

The LatticeECP/EC devices have been carefully designed to ensure predictable behavior during power-up and power-down. Power supplies can be sequenced in any order. During power up and power-down sequences, the I/Os remain in tristate until the power supply voltage is high enough to ensure reliable operation. In addition, leakage into I/O pins is controlled within specified limits, this allows for easy integration with the rest of the system. These capabilities make the LatticeECP/EC ideal for many multiple power supply and hot-swap applications.

Configuration and Testing

The following section describes the configuration and testing features of the LatticeECP/EC devices.

IEEE 1149.1-Compliant Boundary Scan Testability

All LatticeECP/EC devices have boundary scan cells that are accessed through an IEEE 1149.1 compliant test access port (TAP). This allows functional testing of the circuit board, on which the device is mounted, through a serial scan path that can access all critical logic nodes. Internal registers are linked internally, allowing test data to

be shifted in and loaded directly onto test nodes, or test data to be captured and shifted out for verification. The test access port consists of dedicated I/Os: TDI, TDO, TCK and TMS. The test access port has its own supply voltage V_{CCJ} and can operate with LVCMOS3.3, 2.5, 1.8, 1.5 and 1.2 standards.

For more details on boundary scan test, please see information regarding additional technical documentation at the end of this data sheet.

Device Configuration

All LatticeECP/EC devices contain two possible ports that can be used for device configuration. The test access port (TAP), which supports bit-wide configuration, and the sysCONFIG port that supports both byte-wide and serial configuration.

The TAP supports both the IEEE Std. 1149.1 Boundary Scan specification and the IEEE Std. 1532 In-System Configuration specification. The sysCONFIG port is a 20-pin interface with six of the I/Os used as dedicated pins and the rest being dual-use pins (please refer to TN1053 for more information about using the dual-use pins as general purpose I/O). There are four configuration options for LatticeECP/EC devices:

1. Industry standard SPI memories.
2. Industry standard byte wide flash and ispMACH 4000 for control/addressing.
3. Configuration from system microprocessor via the configuration bus or TAP.
4. Industry standard FPGA board memory.

On power-up, the FPGA SRAM is ready to be configured with the sysCONFIG port active. The IEEE 1149.1 serial mode can be activated any time after power-up by sending the appropriate command through the TAP port. Once a configuration port is selected, that port is locked and another configuration port cannot be activated until the next power-up sequence.

For more information about device configuration, please see the list of technical documentation at the end of this data sheet.

Internal Logic Analyzer Capability (ispTRACY)

All LatticeECP/EC devices support an internal logic analyzer diagnostic feature. The diagnostic features provide capabilities similar to an external logic analyzer, such as programmable event and trigger condition and deep trace memory. This feature is enabled by Lattice's ispTRACY. The ispTRACY utility is added into the user design at compile time.

For more information about ispTRACY, please see information regarding additional technical documentation at the end of this data sheet.

External Resistor

LatticeECP/EC devices require a single external, 10K ohm +/- 1% value between the XRES pin and ground. Device configuration will not be completed if this resistor is missing. There is no boundary scan register on the external resistor pad.

sysI/O Single-Ended DC Electrical Characteristics

Input/Output Standard	V_{IL}		V_{IH}		V_{OL} Max. (V)	V_{OH} Min. (V)	I_{OL}^1 (mA)	I_{OH}^1 (mA)
	Min. (V)	Max. (V)	Min. (V)	Max. (V)				
LVCMOS 3.3	-0.3	0.8	2.0	3.6	0.4	$V_{CCIO} - 0.4$	20, 16, 12, 8, 4	-20, -16, -12, -8, -4
					0.2	$V_{CCIO} - 0.2$	0.1	-0.1
LVTTTL	-0.3	0.8	2.0	3.6	0.4	$V_{CCIO} - 0.4$	20, 16, 12, 8, 4	-20, -16, -12, -8, -4
					0.2	$V_{CCIO} - 0.2$	0.1	-0.1
LVCMOS 2.5	-0.3	0.7	1.7	3.6	0.4	$V_{CCIO} - 0.4$	20, 16, 12, 8, 4	-20, -16, -12, -8, -4
					0.2	$V_{CCIO} - 0.2$	0.1	-0.1
LVCMOS 1.8	-0.3	$0.35V_{CCIO}$	$0.65V_{CCIO}$	3.6	0.4	$V_{CCIO} - 0.4$	16, 12, 8, 4	-16, -12, -8, -4
					0.2	$V_{CCIO} - 0.2$	0.1	-0.1
LVCMOS 1.5	-0.3	$0.35V_{CCIO}$	$0.65V_{CCIO}$	3.6	0.4	$V_{CCIO} - 0.4$	8, 4	-8, -4
					0.2	$V_{CCIO} - 0.2$	0.1	-0.1
LVCMOS 1.2	-0.3	$0.35V_{CC}$	$0.65V_{CC}$	3.6	0.4	$V_{CCIO} - 0.4$	6, 2	-6, -2
					0.2	$V_{CCIO} - 0.2$	0.1	-0.1
PCI	-0.3	$0.3V_{CCIO}$	$0.5V_{CCIO}$	3.6	$0.1V_{CCIO}$	$0.9V_{CCIO}$	1.5	-0.5
SSTL3 class I	-0.3	$V_{REF} - 0.2$	$V_{REF} + 0.2$	3.6	0.7	$V_{CCIO} - 1.1$	8	-8
SSTL3 class II	-0.3	$V_{REF} - 0.2$	$V_{REF} + 0.2$	3.6	0.5	$V_{CCIO} - 0.9$	16	-16
SSTL2 class I	-0.3	$V_{REF} - 0.18$	$V_{REF} + 0.18$	3.6	0.54	$V_{CCIO} - 0.62$	7.6	-7.6
SSTL2 class II	-0.3	$V_{REF} - 0.18$	$V_{REF} + 0.18$	3.6	0.35	$V_{CCIO} - 0.43$	15.2	-15.2
SSTL18 class I	-0.3	$V_{REF} - 0.125$	$V_{REF} + 0.125$	3.6	0.4	$V_{CCIO} - 0.4$	6.7	-6.7
HSTL15 class I	-0.3	$V_{REF} - 0.1$	$V_{REF} + 0.1$	3.6	0.4	$V_{CCIO} - 0.4$	8	-8
HSTL15 class III	-0.3	$V_{REF} - 0.1$	$V_{REF} + 0.1$	3.6	0.4	$V_{CCIO} - 0.4$	24	-8
HSTL18 class I	-0.3	$V_{REF} - 0.1$	$V_{REF} + 0.1$	3.6	0.4	$V_{CCIO} - 0.4$	9.6	-9.6
HSTL18 class II	-0.3	$V_{REF} - 0.1$	$V_{REF} + 0.1$	3.6	0.4	$V_{CCIO} - 0.4$	16	-16
HSTL18 class III	-0.3	$V_{REF} - 0.1$	$V_{REF} + 0.1$	3.6	0.4	$V_{CCIO} - 0.4$	24	-8

1. The average DC current drawn by I/Os between GND connections, or between the last GND in an I/O bank and the end of an I/O bank, as shown in the logic signal connections table shall not exceed $n * 8\text{mA}$. Where n is the number of I/Os between bank GND connections or between the last GND in a bank and the end of a bank.

Differential HSTL and SSTL

Differential HSTL and SSTL outputs are implemented as a pair of complementary single-ended outputs. All allowable single-ended output classes (class I and class II) are supported in this mode.

LVDS25E

The top and bottom side of LatticeECP/EC devices support LVDS outputs via emulated complementary LVCMOS outputs in conjunction with a parallel resistor across the driver outputs. The scheme shown in

Figure 3-1 is one possible solution for point-to-point signals.

Figure 3-1. LVDS25E Output Termination Example

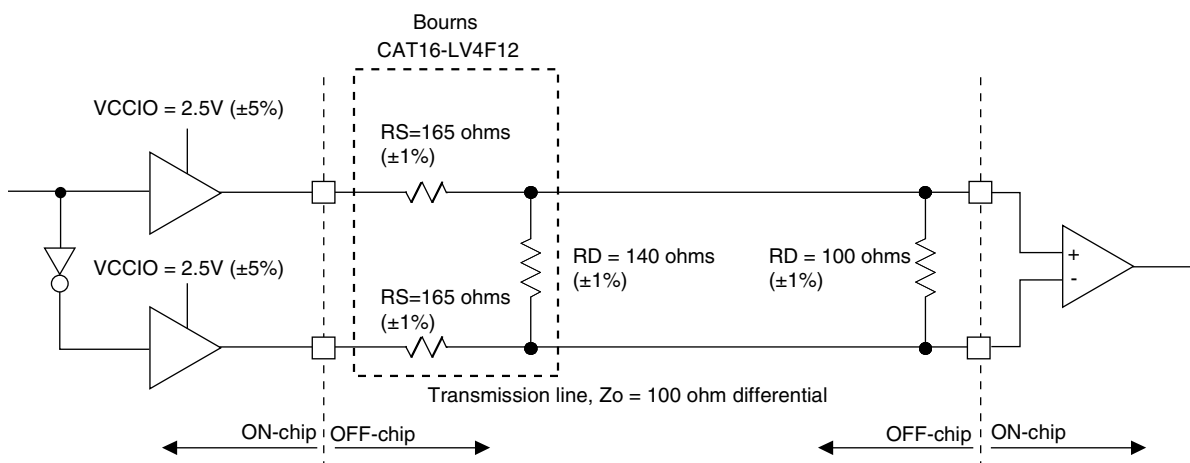


Table 3-1. LVDS25E DC Conditions

Parameter	Description	Typical	Units
V_{OH}	Output high voltage	1.42	V
V_{OL}	Output low voltage	1.08	V
V_{OD}	Output differential voltage	0.35	V
V_{CM}	Output common mode voltage	1.25	V
Z_{BACK}	Back impedance	100	$\%$

RSDS

The LatticeECP/EC devices support differential RSDS standard. This standard is emulated using complementary LVCMOS outputs in conjunction with a parallel resistor across the driver outputs. The RSDS input standard is supported by the LVDS differential input buffer. The scheme shown in Figure 3-4 is one possible solution for RSDS standard implementation. Use LVDS25E mode with suggested resistors for RSDS operation. Resistor values in Figure 3-4 are industry standard values for 1% resistors.

Figure 3-4. RSDS (Reduced Swing Differential Standard)

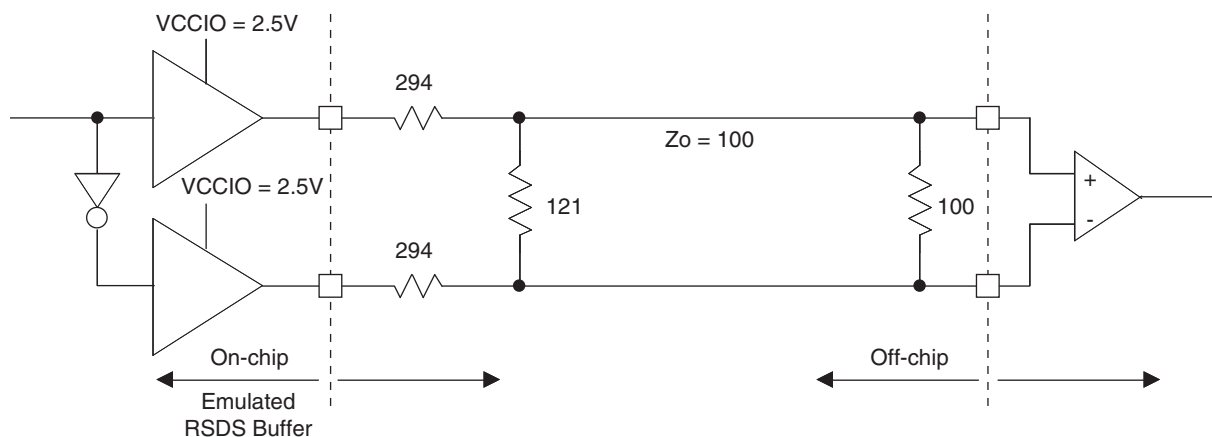


Table 3-4. RSDS DC Conditions

Parameter	Description	Typical	Units
Z _{OUT}	Output impedance	20	ohm
R _S	Driver series resistor	294	ohm
R _P	Driver parallel resistor	121	ohm
R _T	Receiver termination	100	ohm
V _{OH}	Output high voltage	1.35	V
V _{OL}	Output low voltage	1.15	V
V _{OD}	Output differential voltage	0.20	V
V _{CM}	Output common mode voltage	1.25	V
Z _{BACK}	Back impedance	101.5	ohm
I _{DC}	DC output current	3.66	mA

Timing Diagrams

PFU Timing Diagrams

Figure 3-6. Slice Single/Dual Port Write Cycle Timing

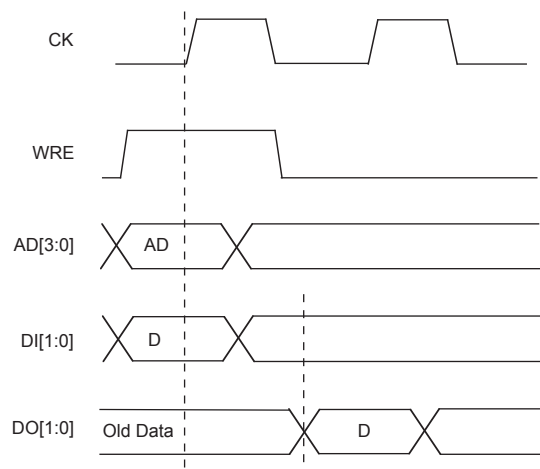


Figure 3-7. Slice Single /Dual Port Read Cycle Timing



LatticeECP/EC sysCONFIG Port Timing Specifications

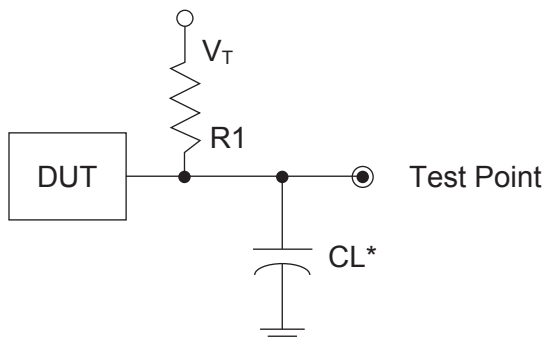
Over Recommended Operating Conditions

Parameter	Description	Min.	Typ.	Max.	Units
sysCONFIG Byte Data Flow					
t_{SUCBDI}	Byte D[0:7] Setup Time to CCLK	7		—	ns
$t_{HCB DI}$	Byte D[0:7] Hold Time to CCLK	1		—	ns
t_{CODO}	Clock to Dout in Flowthrough Mode	—		12	ns
t_{SUCS}	CS[0:1] Setup Time to CCLK	7		—	ns
t_{HCS}	CS[0:1] Hold Time to CCLK	1		—	ns
t_{SUWD}	Write Signal Setup Time to CCLK	7		—	ns
t_{HWD}	Write Signal Hold Time to CCLK	1		—	ns
t_{DCB}	CCLK to BUSY Delay Time	—		12	ns
t_{CORD}	Clock to Out for Read Data	—		12	ns
sysCONFIG Byte Slave Clocking					
t_{BSCH}	Byte Slave Clock Minimum High Pulse	6		—	ns
t_{BSCL}	Byte Slave Clock Minimum Low Pulse	9		—	ns
t_{BSCYC}	Byte Slave Clock Cycle Time	15		—	ns
t_{SUSCDI}	Din Setup time to CCLK Slave Mode	7		—	ns
t_{HSCDI}	Din Hold Time to CCLK Slave Mode	1		—	ns
t_{CODO}	Clock to Dout in Flowthrough Mode	—		12	ns
sysCONFIG Serial (Bit) Data Flow					
t_{SUMCDI}	Din Setup time to CCLK Master Mode	7		—	ns
$t_{HMC DI}$	Din Hold Time to CCLK Master Mode	1		—	ns
sysCONFIG Serial Slave Clocking					
t_{SSCH}	Serial Slave Clock Minimum High Pulse	6		—	ns
t_{SSCL}	Serial Slave Clock Minimum Low Pulse	6		—	ns
sysCONFIG POR, Initialization and Wake Up					
t_{ICFG}	Minimum Vcc to INIT High	—		50	ms
t_{VMC}	Time from t_{ICFG} to Valid Master Clock	—		2	us
t_{PRGMRJ}	Program Pin Pulse Rejection	—		8	ns
t_{PRGM}	PROGRAMN Low Time to Start Configuration	25		—	ns
t_{DINIT}	INIT Low Time	—		1	ms
$t_{DPPINIT}$	Delay Time from PROGRAMN Low to INIT Low	—		37	ns
t_{DINITD}	Delay Time from PROGRAMN Low to DONE Low	—		37	ns
t_{IODISS}	User I/O Disable from PROGRAMN Low	—		35	ns
t_{IOENSS}	User I/O Enabled Time from CCLK Edge During Wake Up Sequence	—		25	ns
t_{MWC}	Additional Wake Master Clock Signals after Done Pin High	120		—	cycles
t_{SUCFG}	CFG to INITN Setup Time	100		—	ns
t_{HCFG}	CFG to INITN Hold Time	100		—	ns
sysCONFIG SPI Port					
t_{CFGX}	Init High to CCLK Low	—		80	ns
t_{CSSPI}	Init High to CSSPIN Low	—		2	us
t_{CSCCLK}	CCLK Low Before CSSPIN Low	0		-	ns
t_{SOCDO}	CCLK Low to Output Valid	—		15	ns

Switching Test Conditions

Figure 3-21 shows the output test load that is used for AC testing. The specific values for resistance, capacitance, voltage, and other test conditions are shown in Table 3-6.

Figure 3-21. Output Test Load, LVTTTL and LVCMOS Standards



*CL Includes Test Fixture and Probe Capacitance

Table 3-6. Test Fixture Required Components, Non-Terminated Interfaces

Test Condition	R_1	C_L	Timing Ref.	V_T
LVTTTL and other LVCMOS settings (L -> H, H -> L)	∞	0pF	LVCMOS 3.3 = 1.5V	—
			LVCMOS 2.5 = $V_{CCIO}/2$	—
			LVCMOS 1.8 = $V_{CCIO}/2$	—
			LVCMOS 1.5 = $V_{CCIO}/2$	—
			LVCMOS 1.2 = $V_{CCIO}/2$	—
LVCMOS 2.5 I/O (Z -> H)	188 $\frac{3}{4}$	0pF	$V_{CCIO}/2$	V_{OL}
LVCMOS 2.5 I/O (Z -> L)			$V_{CCIO}/2$	V_{OH}
LVCMOS 2.5 I/O (H -> Z)			$V_{OH} - 0.15$	V_{OL}
LVCMOS 2.5 I/O (L -> Z)			$V_{OL} + 0.15$	V_{OH}

Note: Output test conditions for all other interfaces are determined by the respective standards.

LFEC6P/EC6, LFEC6P/EC10 Logic Signal Connections: 208 PQFP (Cont.)

Pin Number	LFEC6P/EC6				LFEC6P/EC10			
	Pin Function	Bank	LVDS	Dual Function	Pin Function	Bank	LVDS	Dual Function
43	PL24A	6	T	LDQS24	PL33A	6	T	LDQS33
44	PL24B	6	C		PL33B	6	C	
45	PL25A	6	T		PL34A	6	T	
46	PL25B	6	C		PL34B	6	C	
47	PL26A	6	T		PL35A	6	T	
48	PL26B	6	C		PL35B	6	C	
49	PL27A	6	T	VREF1_6	PL36A	6	T	VREF1_6
50	PL27B	6	C	VREF2_6	PL36B	6	C	VREF2_6
51	VCCIO6	6			VCCIO6	6		
52*	GND5 GND6	-			GND5 GND6	-		
53	VCCIO5	5			VCCIO5	5		
54	PB2A	5	T		PB2A	5	T	
55	PB2B	5	C		PB2B	5	C	
56	PB3A	5	T		PB3A	5	T	
57	PB3B	5	C		PB3B	5	C	
58	PB4A	5	T		PB4A	5	T	
59	PB4B	5	C		PB4B	5	C	
60	PB5A	5	T		PB5A	5	T	
61	PB5B	5	C		PB5B	5	C	
62	PB6A	5	T	BDQS6	PB6A	5	T	BDQS6
63	PB6B	5	C		PB6B	5	C	
64	VCCIO5	5			VCCIO5	5		
65	PB10A	5	T		PB18A	5	T	
66	PB10B	5	C		PB18B	5	C	
67	PB11A	5	T		PB19A	5	T	
68	PB11B	5	C		PB19B	5	C	
69	PB12A	5	T		PB20A	5	T	
70	PB12B	5	C		PB20B	5	C	
71	PB13A	5	T		PB21A	5	T	
72	GND5	5			GND5	5		
73	PB13B	5	C		PB21B	5	C	
74	VCCIO5	5			VCCIO5	5		
75	PB14A	5	T	BDQS14	PB22A	5	T	BDQS22
76	PB14B	5	C		PB22B	5	C	
77	PB15A	5	T		PB23A	5	T	
78	PB15B	5	C		PB23B	5	C	
79	PB16A	5	T	VREF2_5	PB24A	5	T	VREF2_5
80	PB16B	5	C	VREF1_5	PB24B	5	C	VREF1_5
81	PB17A	5	T	PCLKT5_0	PB25A	5	T	PCLKT5_0
82	GND5	5			GND5	5		
83	PB17B	5	C	PCLKC5_0	PB25B	5	C	PCLKC5_0
84	VCCAUX	-			VCCAUX	-		

LFEC6P/EC6, LFEC6P/EC10 Logic Signal Connections: 208 PQFP (Cont.)

Pin Number	LFEC6P/EC6				LFEC6P/EC10			
	Pin Function	Bank	LVDS	Dual Function	Pin Function	Bank	LVDS	Dual Function
127	CFG0	3			CFG0	3		
128	VCC	-			VCC	-		
129	PROGRAMN	3			PROGRAMN	3		
130	CCLK	3			CCLK	3		
131	INITN	3			INITN	3		
132	GND	-			GND	-		
133	DONE	3			DONE	3		
134	GND	-			GND	-		
135	VCC	-			VCC	-		
136	VCCAUX	-			VCCAUX	-		
137	PR9B	2	C	PCLKC2_0	PR18B	2	C	PCLKC2_0
138	GND2	2			GND2	2		
139	PR9A	2	T	PCLKT2_0	PR18A	2	T	PCLKT2_0
140	PR8B	2	C		PR17B	2	C	
141	PR8A	2	T		PR17A	2	T	
142	PR7B	2	C		PR16B	2	C	
143	PR7A	2	T		PR16A	2	T	
144	PR6B	2	C		PR15B	2	C	
145	VCCIO2	2			VCCIO2	2		
146	PR6A	2	T	RDQS6	PR15A	2	T	RDQS15
147	PR5B	2	C		PR14B	2	C	
148	PR5A	2	T		PR14A	2	T	
149	PR4B	2	C		PR13B	2	C	
150	PR4A	2	T		PR13A	2	T	
151	NC	-			GND	-		
152	NC	-			VCC	-		
153	PR2B	2	C	VREF1_2	PR2B	2	C	VREF1_2
154	PR2A	2	T	VREF2_2	PR2A	2	T	VREF2_2
155	VCCIO2	2			VCCIO2	2		
156*	GND1 GND2	-			GND1 GND2	-		
157	VCCIO1	1			VCCIO1	1		
158	PT33A	1			PT41A	1		
159	PT25B	1	C		PT33B	1	C	
160	PT25A	1	T		PT33A	1	T	
161	PT24B	1	C		PT32B	1	C	
162	PT24A	1	T		PT32A	1	T	
163	PT23B	1	C		PT31B	1	C	
164	PT23A	1	T		PT31A	1	T	
165	PT22B	1	C		PT30B	1	C	
166	PT22A	1	T	TDQS22	PT30A	1	T	TDQS30
167	PT21B	1	C		PT29B	1	C	
168	GND1	1			GND1	1		

LFEC6/EC6, LFEC6/EC10 Logic Signal Connections: 208 PQFP (Cont.)

Pin Number	LFEC6/LFEC6				LFEC10/LFEC10			
	Pin Function	Bank	LVDS	Dual Function	Pin Function	Bank	LVDS	Dual Function
169	PT21A	1	T		PT29A	1	T	
170	PT20B	1	C		PT28B	1	C	
171	PT20A	1	T		PT28A	1	T	
172	PT19B	1	C	VREF2_1	PT27B	1	C	VREF2_1
173	PT19A	1	T	VREF1_1	PT27A	1	T	VREF1_1
174	PT18B	1	C		PT26B	1	C	
175	PT18A	1	T		PT26A	1	T	
176	VCCIO1	1			VCCIO1	1		
177	VCCAUX	-			VCCAUX	-		
178	PT17B	0	C	PCLKC0_0	PT25B	0	C	PCLKC0_0
179	GND0	0			GND0	0		
180	PT17A	0	T	PCLKT0_0	PT25A	0	T	PCLKT0_0
181	PT16B	0	C	VREF1_0	PT24B	0	C	VREF1_0
182	PT16A	0	T	VREF2_0	PT24A	0	T	VREF2_0
183	PT15B	0	C		PT23B	0	C	
184	PT15A	0	T		PT23A	0	T	
185	PT14B	0	C		PT22B	0	C	
186	PT14A	0	T	TDQS14	PT22A	0	T	TDQS22
187	VCCIO0	0			VCCIO0	0		
188	PT13B	0	C		PT21B	0	C	
189	GND0	0			GND0	0		
190	PT13A	0	T		PT21A	0	T	
191	PT12B	0	C		PT20B	0	C	
192	PT12A	0	T		PT20A	0	T	
193	PT11B	0	C		PT19B	0	C	
194	PT11A	0	T		PT19A	0	T	
195	PT10B	0	C		PT18B	0	C	
196	PT10A	0	T		PT18A	0	T	
197	VCCIO0	0			VCCIO0	0		
198	PT6B	0	C		PT6B	0	C	
199	PT6A	0	T	TDQS6	PT6A	0	T	TDQS6
200	PT5B	0	C		PT5B	0	C	
201	PT5A	0	T		PT5A	0	T	
202	PT4B	0	C		PT4B	0	C	
203	PT4A	0	T		PT4A	0	T	
204	PT3B	0	C		PT3B	0	C	
205	PT3A	0	T		PT3A	0	T	
206	PT2B	0	C		PT2B	0	C	
207	PT2A	0	T		PT2A	0	T	
208	VCCIO0	0			VCCIO0	0		

*Double bonded to the pin.

LFECP/EC10 and LFECP/EC15 Logic Signal Connections: 256 fpBGA (Cont.)

Ball Number	LFECP10/LFEC10				LFECP15/LFEC15			
	Ball Function	Bank	LVDS	Dual Function	Ball Function	Bank	LVDS	Dual Function
L3	TMS	6			TMS	6		
L5	TDO	6			TDO	6		
L4	VCCJ	6			VCCJ	6		
K2	PL29A	6	T	LLM0_PLLT_IN_A	PL37A	6	T	LLM0_PLLT_IN_A
K1	PL29B	6	C	LLM0_PLLC_IN_A	PL37B	6	C	LLM0_PLLC_IN_A
L2	PL30A	6	T	LLM0_PLLT_FB_A	PL38A	6	T	LLM0_PLLT_FB_A
L1	PL30B	6	C	LLM0_PLLC_FB_A	PL38B	6	C	LLM0_PLLC_FB_A
M2	PL31A	6	T		PL39A	6	T	
M1	PL31B	6	C		PL39B	6	C	
N1	PL32A	6	T		PL40A	6	T	
GND	GND6	6			GND6	6		
-	-	-			GND6	6		
N2	PL32B	6	C		PL40B	6	C	
M4	PL33A	6	T	LDQS33	PL41A	6	T	LDQS41
M3	PL33B	6	C		PL41B	6	C	
P1	PL34A	6	T		PL42A	6	T	
R1	PL34B	6	C		PL42B	6	C	
P2	PL35A	6	T		PL43A	6	T	
P3	PL35B	6	C		PL43B	6	C	
N3	PL36A	6	T	VREF1_6	PL44A	6	T	VREF1_6
N4	PL36B	6	C	VREF2_6	PL44B	6	C	VREF2_6
GND	GND6	6			GND6	6		
GND	GND5	5			GND5	5		
GND	GND5	5			GND5	5		
P4	PB10A	5	T		PB10A	5	T	
N5	PB10B	5	C		PB10B	5	C	
P5	PB11A	5	T		PB11A	5	T	
P6	PB11B	5	C		PB11B	5	C	
R4	PB12A	5	T		PB12A	5	T	
R3	PB12B	5	C		PB12B	5	C	
T2	PB13A	5	T		PB13A	5	T	
GND	GND5	5			GND5	5		
T3	PB13B	5	C		PB13B	5	C	
R5	PB14A	5	T	BDQS14	PB14A	5	T	BDQS14
R6	PB14B	5	C		PB14B	5	C	
T4	PB15A	5	T		PB15A	5	T	
T5	PB15B	5	C		PB15B	5	C	
N6	PB16A	5	T		PB16A	5	T	
M6	PB16B	5	C		PB16B	5	C	
T6	PB17A	5	T		PB17A	5	T	
GND	GND5	5			GND5	5		
T7	PB17B	5	C		PB17B	5	C	
P7	PB18A	5	T		PB18A	5	T	

LFEC6/EC6, LFEC6/EC10, LFEC6/EC15 Logic Signal Connections: 484 fpBGA (Cont.)

LFEC6/LFEC6					LFEC10/LFEC10					LFEC15/LFEC15				
Ball Number	Ball Function	Bank	LVDS	Dual Function	Ball Number	Ball Function	Bank	LVDS	Dual Function	Ball Number	Ball Function	Bank	LVDS	Dual Function
T11	VCCIO5	5			T11	VCCIO5	5			T11	VCCIO5	5		
M7	VCCIO6	6			M7	VCCIO6	6			M7	VCCIO6	6		
M8	VCCIO6	6			M8	VCCIO6	6			M8	VCCIO6	6		
N8	VCCIO6	6			N8	VCCIO6	6			N8	VCCIO6	6		
P8	VCCIO6	6			P8	VCCIO6	6			P8	VCCIO6	6		
J8	VCCIO7	7			J8	VCCIO7	7			J8	VCCIO7	7		
K8	VCCIO7	7			K8	VCCIO7	7			K8	VCCIO7	7		
L7	VCCIO7	7			L7	VCCIO7	7			L7	VCCIO7	7		
L8	VCCIO7	7			L8	VCCIO7	7			L8	VCCIO7	7		
G15	VCCAUX	-			G15	VCCAUX	-			G15	VCCAUX	-		
G16	VCCAUX	-			G16	VCCAUX	-			G16	VCCAUX	-		
G7	VCCAUX	-			G7	VCCAUX	-			G7	VCCAUX	-		
G8	VCCAUX	-			G8	VCCAUX	-			G8	VCCAUX	-		
H16	VCCAUX	-			H16	VCCAUX	-			H16	VCCAUX	-		
H7	VCCAUX	-			H7	VCCAUX	-			H7	VCCAUX	-		
R16	VCCAUX	-			R16	VCCAUX	-			R16	VCCAUX	-		
R7	VCCAUX	-			R7	VCCAUX	-			R7	VCCAUX	-		
T15	VCCAUX	-			T15	VCCAUX	-			T15	VCCAUX	-		
T16	VCCAUX	-			T16	VCCAUX	-			T16	VCCAUX	-		
T7	VCCAUX	-			T7	VCCAUX	-			T7	VCCAUX	-		
T8	VCCAUX	-			T8	VCCAUX	-			T8	VCCAUX	-		
J6	VCC	-			J6	VCC	-			J6	VCC	-		
J17	VCC	-			J17	VCC	-			J17	VCC	-		
P6	VCC	-			P6	VCC	-			P6	VCC	-		
P17	VCC	-			P17	VCC	-			P17	VCC	-		
A2	NC	-			A2	NC	-			A2	NC	-		
AB2	NC	-			AB2	NC	-			AB2	NC	-		
A21	NC	-			A21	NC	-			A21	NC	-		

LFEC20/EC20 and LFEC20/EC33 Logic Signal Connections: 484 fpBGA (Cont.)

LFEC20/LFEC20					LFEC20/LFEC33				
Ball Number	Ball Function	Bank	LVD S	Dual Function	Ball Number	Ball Function	Bank	LVD S	Dual Function
A7	PT27B	0	C		A7	PT27B	0	C	
A6	PT27A	0	T		A6	PT27A	0	T	
B7	PT26B	0	C		B7	PT26B	0	C	
B8	PT26A	0	T		B8	PT26A	0	T	
A5	PT25B	0	C		A5	PT25B	0	C	
GND	GND0	0			GND	GND0	0		
B6	PT25A	0	T		B6	PT25A	0	T	
G10	PT24B	0	C		G10	PT24B	0	C	
E10	PT24A	0	T		E10	PT24A	0	T	
F10	PT23B	0	C		F10	PT23B	0	C	
D10	PT23A	0	T		D10	PT23A	0	T	
G9	PT22B	0	C		G9	PT22B	0	C	
E9	PT22A	0	T	TDQS22	E9	PT22A	0	T	TDQS22
C9	PT21B	0	C		C9	PT21B	0	C	
GND	GND0	0			GND	GND0	0		
C8	PT21A	0	T		C8	PT21A	0	T	
F9	PT20B	0	C		F9	PT20B	0	C	
D9	PT20A	0	T		D9	PT20A	0	T	
F8	PT19B	0	C		F8	PT19B	0	C	
D7	PT19A	0	T		D7	PT19A	0	T	
D8	PT18B	0	C		D8	PT18B	0	C	
C7	PT18A	0	T		C7	PT18A	0	T	
GND	GND0	0			GND	GND0	0		
A4	PT17B	0	C		A4	PT17B	0	C	
B4	PT17A	0	T		B4	PT17A	0	T	
C4	PT16B	0	C		C4	PT16B	0	C	
C5	PT16A	0	T		C5	PT16A	0	T	
D6	PT15B	0	C		D6	PT15B	0	C	
B5	PT15A	0	T		B5	PT15A	0	T	
E6	PT14B	0	C		E6	PT14B	0	C	
C6	PT14A	0	T	TDQS14	C6	PT14A	0	T	TDQS14
A3	PT13B	0	C		A3	PT13B	0	C	
GND	GND0	0			GND	GND0	0		
B3	PT13A	0	T		B3	PT13A	0	T	
F6	PT12B	0	C		F6	PT12B	0	C	
D5	PT12A	0	T		D5	PT12A	0	T	
F7	PT11B	0	C		F7	PT11B	0	C	
E8	PT11A	0	T		E8	PT11A	0	T	
G6	PT10B	0	C		G6	PT10B	0	C	
E7	PT10A	0	T		E7	PT10A	0	T	
GND	GND0	0			GND	GND0	0		
GND	GND0	0			GND	GND0	0		
A1	GND	-			A1	GND	-		
A22	GND	-			A22	GND	-		

LFECP/EC20 and LFECP/EC33 Logic Signal Connections: 484 fpBGA (Cont.)

LFECP20/LFEC20					LFECP/LFEC33				
Ball Number	Ball Function	Bank	LVD S	Dual Function	Ball Number	Ball Function	Bank	LVD S	Dual Function
L7	VCCIO7	7			L7	VCCIO7	7		
L8	VCCIO7	7			L8	VCCIO7	7		
G15	VCCAUX	-			G15	VCCAUX	-		
G16	VCCAUX	-			G16	VCCAUX	-		
G7	VCCAUX	-			G7	VCCAUX	-		
G8	VCCAUX	-			G8	VCCAUX	-		
H16	VCCAUX	-			H16	VCCAUX	-		
H7	VCCAUX	-			H7	VCCAUX	-		
R16	VCCAUX	-			R16	VCCAUX	-		
R7	VCCAUX	-			R7	VCCAUX	-		
T15	VCCAUX	-			T15	VCCAUX	-		
T16	VCCAUX	-			T16	VCCAUX	-		
T7	VCCAUX	-			T7	VCCAUX	-		
T8	VCCAUX	-			T8	VCCAUX	-		
J6	VCC ¹	-			J6	VCCPLL	-		
J17	VCC ¹	-			J17	VCCPLL	-		
P6	VCC ¹	-			P6	VCCPLL	-		
P17	VCC ¹	-			P17	VCCPLL	-		
A2	NC	-			A2	NC	-		
AB2	NC	-			AB2	NC	-		
A21	NC	-			A21	NC	-		

 1. Tied to V_{CCPLL}.

LFECP/EC20, LFECP/EC33 Logic Signal Connections: 672 fpBGA (Cont.)

LFEC20/LFECP20					LFECP/EC33				
Ball Number	Ball Function	Bank	LVDS	Dual Function	Ball Number	Ball Function	Bank	LVDS	Dual Function
A5	PT13B	0	C		A5	PT13B	0	C	
GND	GND0	0			GND	GND0	0		
A4	PT13A	0	T		A4	PT13A	0	T	
F9	PT12B	0	C		F9	PT12B	0	C	
B6	PT12A	0	T		B6	PT12A	0	T	
E9	PT11B	0	C		E9	PT11B	0	C	
C8	PT11A	0	T		C8	PT11A	0	T	
G8	PT10B	0	C		G8	PT10B	0	C	
B5	PT10A	0	T		B5	PT10A	0	T	
A3	PT9B	0	C		A3	PT9B	0	C	
GND	GND0	0			GND	GND0	0		
A2	PT9A	0	T		A2	PT9A	0	T	
F8	PT8B	0	C		F8	PT8B	0	C	
B4	PT8A	0	T		B4	PT8A	0	T	
E8	PT7B	0	C		E8	PT7B	0	C	
B3	PT7A	0	T		B3	PT7A	0	T	
D8	PT6B	0	C		D8	PT6B	0	C	
G7	PT6A	0	T	TDQS6	G7	PT6A	0	T	TDQS6
C4	PT5B	0	C		C4	PT5B	0	C	
C5	PT5A	0	T		C5	PT5A	0	T	
E7	PT4B	0	C		E7	PT4B	0	C	
D4	PT4A	0	T		D4	PT4A	0	T	
F7	PT3B	0	C		F7	PT3B	0	C	
D6	PT3A	0	T		D6	PT3A	0	T	
D7	PT2B	0	C		D7	PT2B	0	C	
E6	PT2A	0	T		E6	PT2A	0	T	
GND	GND0	0			GND	GND0	0		
K10	GND	-			K10	GND	-		
K11	GND	-			K11	GND	-		
K12	GND	-			K12	GND	-		
K13	GND	-			K13	GND	-		
K14	GND	-			K14	GND	-		
K15	GND	-			K15	GND	-		
K16	GND	-			K16	GND	-		
L10	GND	-			L10	GND	-		
L11	GND	-			L11	GND	-		
L12	GND	-			L12	GND	-		
L13	GND	-			L13	GND	-		
L14	GND	-			L14	GND	-		
L15	GND	-			L15	GND	-		
L16	GND	-			L16	GND	-		
L17	GND	-			L17	GND	-		

LFECP/EC20, LFECP/EC33 Logic Signal Connections: 672 fpBGA (Cont.)

LFEC20/LFECP20					LFECP/EC33				
Ball Number	Ball Function	Bank	LVDS	Dual Function	Ball Number	Ball Function	Bank	LVDS	Dual Function
J14	VCCIO1	1			J14	VCCIO1	1		
J15	VCCIO1	1			J15	VCCIO1	1		
J16	VCCIO1	1			J16	VCCIO1	1		
J17	VCCIO1	1			J17	VCCIO1	1		
K17	VCCIO2	2			K17	VCCIO2	2		
K18	VCCIO2	2			K18	VCCIO2	2		
L18	VCCIO2	2			L18	VCCIO2	2		
M18	VCCIO2	2			M18	VCCIO2	2		
N18	VCCIO2	2			N18	VCCIO2	2		
N19	VCCIO2	2			N19	VCCIO2	2		
P18	VCCIO3	3			P18	VCCIO3	3		
P19	VCCIO3	3			P19	VCCIO3	3		
R18	VCCIO3	3			R18	VCCIO3	3		
R19	VCCIO3	3			R19	VCCIO3	3		
T18	VCCIO3	3			T18	VCCIO3	3		
U18	VCCIO3	3			U18	VCCIO3	3		
V14	VCCIO4	4			V14	VCCIO4	4		
V15	VCCIO4	4			V15	VCCIO4	4		
V16	VCCIO4	4			V16	VCCIO4	4		
V17	VCCIO4	4			V17	VCCIO4	4		
W14	VCCIO4	4			W14	VCCIO4	4		
W15	VCCIO4	4			W15	VCCIO4	4		
V10	VCCIO5	5			V10	VCCIO5	5		
V11	VCCIO5	5			V11	VCCIO5	5		
V12	VCCIO5	5			V12	VCCIO5	5		
V13	VCCIO5	5			V13	VCCIO5	5		
W12	VCCIO5	5			W12	VCCIO5	5		
W13	VCCIO5	5			W13	VCCIO5	5		
P8	VCCIO6	6			P8	VCCIO6	6		
P9	VCCIO6	6			P9	VCCIO6	6		
R8	VCCIO6	6			R8	VCCIO6	6		
R9	VCCIO6	6			R9	VCCIO6	6		
T9	VCCIO6	6			T9	VCCIO6	6		
U9	VCCIO6	6			U9	VCCIO6	6		
K9	VCCIO7	7			K9	VCCIO7	7		
L9	VCCIO7	7			L9	VCCIO7	7		
M8	VCCIO7	7			M8	VCCIO7	7		
M9	VCCIO7	7			M9	VCCIO7	7		
N8	VCCIO7	7			N8	VCCIO7	7		
N9	VCCIO7	7			N9	VCCIO7	7		
G13	VCCAUX	-			G13	VCCAUX	-		
H20	VCCAUX	-			H20	VCCAUX	-		

LatticeECP Commercial (Continued)

Part Number	I/Os	Grade	Package	Pins	Temp.	LUTs
LFEC33E-3F484C	360	-3	fpBGA	484	COM	32.8K
LFEC33E-4F484C	360	-4	fpBGA	484	COM	32.8K
LFEC33E-5F484C	360	-5	fpBGA	484	COM	32.8K

LatticeEC Industrial

Part Number	I/Os	Grade	Package	Pins	Temp.	LUTs
LFEC1E-3Q208I	112	-3	PQFP	208	IND	1.5K
LFEC1E-4Q208I	112	-4	PQFP	208	IND	1.5K
LFEC1E-3T144I	97	-3	TQFP	144	IND	1.5K
LFEC1E-4T144I	97	-4	TQFP	144	IND	1.5K
LFEC1E-3T100I	67	-3	TQFP	100	IND	1.5K
LFEC1E-4T100I	67	-4	TQFP	100	IND	1.5K

Part Number	I/Os	Grade	Package	Pins	Temp.	LUTs
LFEC3E-3F256I	160	-3	fpBGA	256	IND	3.1K
LFEC3E-4F256I	160	-4	fpBGA	256	IND	3.1K
LFEC3E-3Q208I	145	-3	PQFP	208	IND	3.1K
LFEC3E-4Q208I	145	-4	PQFP	208	IND	3.1K
LFEC3E-3T144I	97	-3	TQFP	144	IND	3.1K
LFEC3E-4T144I	97	-4	TQFP	144	IND	3.1K
LFEC3E-3T100I	67	-3	TQFP	100	IND	3.1K
LFEC3E-4T100I	67	-4	TQFP	100	IND	3.1K

Part Number	I/Os	Grade	Package	Pins	Temp.	LUTs
LFEC6E-3F484I	224	-3	fpBGA	484	IND	6.1K
LFEC6E-4F484I	224	-4	fpBGA	484	IND	6.1K
LFEC6E-3F256I	195	-3	fpBGA	256	IND	6.1K
LFEC6E-4F256I	195	-4	fpBGA	256	IND	6.1K
LFEC6E-3Q208I	147	-3	PQFP	208	IND	6.1K
LFEC6E-4Q208I	147	-4	PQFP	208	IND	6.1K
LFEC6E-3T144I	97	-3	TQFP	144	IND	6.1K
LFEC6E-4T144I	97	-4	TQFP	144	IND	6.1K

Part Number	I/Os	Grade	Package	Pins	Temp.	LUTs
LFEC10E-3F484I	288	-3	fpBGA	484	IND	10.2K
LFEC10E-4F484I	288	-4	fpBGA	484	IND	10.2K
LFEC10E-3F256I	195	-3	fpBGA	256	IND	10.2K
LFEC10E-4F256I	195	-4	fpBGA	256	IND	10.2K
LFEC10E-3 P208I	147	-3	PQFP	208	IND	10.2K
LFEC10E-4 P208I	147	-4	PQFP	208	IND	10.2K

LatticeEC Commercial (Continued)

Part Number	I/Os	Grade	Package	Pins/Balls	Temp.	LUTs
LFEC10E-4FN256C	195	-4	Lead-Free fpBGA	256	COM	10.2K
LFEC10E-5FN256C	195	-5	Lead-Free fpBGA	256	COM	10.2K
LFEC10E-3QN208C	147	-3	Lead-Free PQFP	208	COM	10.2K
LFEC10E-4QN208C	147	-4	Lead-Free PQFP	208	COM	10.2K
LFEC10E-5QN208C	147	-5	Lead-Free PQFP	208	COM	10.2K

Part Number	I/Os	Grade	Package	Pins/Balls	Temp.	LUTs
LFEC15E-3FN484C	352	-3	Lead-Free fpBGA	484	COM	15.3K
LFEC15E-4FN484C	352	-4	Lead-Free fpBGA	484	COM	15.3K
LFEC15E-5FN484C	352	-5	Lead-Free fpBGA	484	COM	15.3K
LFEC15E-3FN256C	195	-3	Lead-Free fpBGA	256	COM	15.3K
LFEC15E-4FN256C	195	-4	Lead-Free fpBGA	256	COM	15.3K
LFEC15E-5FN256C	195	-5	Lead-Free fpBGA	256	COM	15.3K

Part Number	I/Os	Grade	Package	Pins/Balls	Temp.	LUTs
LFEC20E-3FN672C	400	-3	Lead-Free fpBGA	672	COM	19.7K
LFEC20E-4FN672C	400	-4	Lead-Free fpBGA	672	COM	19.7K
LFEC20E-5FN672C	400	-5	Lead-Free fpBGA	672	COM	19.7K
LFEC20E-3FN484C	360	-3	Lead-Free fpBGA	484	COM	19.7K
LFEC20E-4FN484C	360	-4	Lead-Free fpBGA	484	COM	19.7K
LFEC20E-5FN484C	360	-5	Lead-Free fpBGA	484	COM	19.7K

Part Number	I/Os	Grade	Package	Pins/Balls	Temp.	LUTs
LFEC33E-3FN672C	496	-3	Lead-Free fpBGA	672	COM	32.8K
LFEC33E-4FN672C	496	-4	Lead-Free fpBGA	672	COM	32.8K
LFEC33E-5FN672C	496	-5	Lead-Free fpBGA	672	COM	32.8K
LFEC33E-3FN484C	360	-3	Lead-Free fpBGA	484	COM	32.8K
LFEC33E-4FN484C	360	-4	Lead-Free fpBGA	484	COM	32.8K
LFEC33E-5FN484C	360	-5	Lead-Free fpBGA	484	COM	32.8K